A photoelectrochemical (PEC) process was developed to remove the irregular top layer from InP porous nanostructures. After anodic formation of a nanopore array, the PEC process repeated in the same electrolyte under illumination. The etching rate of the pore surfaces was strongly associated with their structural properties, being greater in the irregular top layer. The irregular top layer was completely removed by monitoring and controlling the anodic photocurrents in the ramped bias mode.

Application of six cycles of ramped bias completely removed the irregular top layer from the InP porous template during six cycles of continuously applied ramped bias under illumination. $V_i$ was swept at a rate of 50 mV/s from 0 to 1 V in the positive direction and then in the negative one, as shown in the inset waveform. As shown in Fig. 2, the highest current density of 5.3 mA/cm² was observed at $V_i = 1$ V in the first cycle. When the ramped bias was repeatedly applied, the current peaks observed in each cycle gradually decreased and then approached the saturation value of 4.0 mA/cm². The result obtained here indicates that the InP porous surface was undergoing some anodic reaction under illumination. However, the behavior of the current transition obtained here is different from that usually obtained on a planar semiconductor electrode. When planar InP substrate was subjected to ramped bias, the photocurrent increased as the number of ramped bias cycles increased because the passive layers, such as native oxides, were anodically dissolved.

Figures 3a and b are plan-view and cross-sectional SEM images of the sample after application of three and six cycles of ramped bias, respectively. We found that the PEC process greatly modified the surface morphology. As shown in Fig. 3a, the lateral size of pores were larger than those of the porous template shown in Fig. 1b. We observed in the SEM cross section that the thickness of the irregular top layer on the porous template decreased from 4.1 to 1.4 μm.

Application of six cycles of ramped bias completely removed the irregular top layer, and the regular array of straight pores appeared on the surface, as shown in Fig. 3b. It is important to remember that the pore shape was a square defined by four equivalent {100} planes, which is similar to the shape of the porous structures after the cathodic decomposition process. This similarity is due to the strong dependence of the etching rate on crystal orientation, where the {100} planes preferentially appeared on the wall surface due to their slow etching rate. The lateral thickness of the InP nanowalls was less than 20 nm near the surface, which is thinner than the initial value of the template porous sample. These results indicate that the porous surface was etched by a PEC reaction.
The etching rate of the InP porous nanostructures was investigated using SEM observation. Figure 4 shows the plot of the etching depth, \( d \), measured from the top surface as a function of the cycle number of the ramped bias applied during the PEC process. It was found that there was an inflection point in the etching curve around the fifth cycle. The surface of the InP porous structure started to be etched at a rate of \( 1.2\ \mu m/\)cycle. After the inflection point, as shown in Fig. 4, the etching rate decreased appreciably to less than \( 0.2\ \mu m/\)cycle. This behavior is consistent with the current transition seen in Fig. 2. It seems clear that the etching rate decreased along with the anodic currents, contributing to the electrochemical dissolution of the InP porous surface.

One explanation for this is that the amount of anodic photocurrents was strongly associated with the structural properties of the InP porous nanostructures. At the beginning of the PEC process, the surface etching started with a large photocurrent due to the hole generation caused by the illumination in the irregular pore region. After the complete removal of the irregular layer with a thickness of \( 4.1\ \mu m \), the etching rate decreased, as shown in Fig. 4, because the effective area subjected to illumination became small on the surface, with InP nanowalls being thinner in the straight pore region. This model qualitatively explains the observed behavior on the PEC etching of the InP porous nanostructures. These results indicate that the...
irregular top layer can be completely removed from the surface of InP porous nanostructures by the PEC process controlling and monitoring the anodic photocurrents.

In summary, a PEC process was developed to remove the irregular top layer from porous InP nanostructures. The PEC etching was conducted in ramped bias mode under illumination, and the complete removal of the irregular layer was made possible by monitoring and controlling the anodic photocurrents. The results obtained here are promising for practical application of these unique InP nanostructures, which cannot be formed using conventional methods.

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References